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## MC74LVX4052

## Analog Multiplexer/ Demultiplexer High-Performance Silicon-Gate CMOS

The MC74LVX4052 utilizes silicon-gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF leakage currents. This analog multiplexer/demultiplexer controls analog voltages that may vary across the complete power supply range (from $\mathrm{V}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{EE}}$ ).

The LVX4052 is similar in pinout to the high-speed HC4052A and the metal-gate MC14052B. The Channel-Select inputs determine which one of the Analog Inputs/Outputs is to be connected, by means of an analog switch, to the Common Output/Input. When the Enable pin is HIGH, all analog switches are turned off.

The Channel-Select and Enable inputs are compatible with standard CMOS outputs; with pull-up resistors, they are compatible with LSTTL outputs.

This device has been designed so the ON resistance $\left(\mathrm{R}_{\mathrm{ON}}\right)$ is more linear over input voltage than the $\mathrm{R}_{\mathrm{ON}}$ of metal-gate CMOS analog switches and High-Speed CMOS analog switches.

## Features

- Fast Switching and Propagation Speeds
- Low Crosstalk Between Switches
- Analog Power Supply Range $\left(\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}\right)=-3.0 \mathrm{~V}$ to +3.0 V
- Digital (Control) Power Supply Range $\left(\mathrm{V}_{\mathrm{CC}}-\mathrm{GND}\right)=2.5$ to 6.0 V
- Improved Linearity and Lower ON Resistance Than Metal-Gate, HSL, or VHC Counterparts
- Low Noise
- Designed to Operate on a Single Supply with $\mathrm{V}_{\mathrm{EE}}=$ GND, or Using Split Supplies up to $\pm 3.0 \mathrm{~V}$
- Break-Before-Make Circuitry
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant


## FUNCTION TABLE

| Control Inputs |  |  |  |  |
| :---: | :---: | :---: | :---: | ---: |
|  | Select |  |  |  |
| Enable | B | A | ON Channels |  |
| L | L | L | Y0 | X0 |
| L | L | H | Y1 | X1 |
| L | H | L | Y2 | X2 |
| L | H | H | Y3 | X3 |
| H | X | X | NONE |  |

[^0]ON Semiconductor ${ }^{\text {® }}$
http://onsemi.com


ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.


NOTE: This device allows independent control of each switch. Channel-Select Input A controls the X-Switch, Input B controls the Y-Switch.

Figure 1. Logic Diagram Double-Pole, 4-Position Plus Common Off

MAXIMUM RATINGS


Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Tested to EIA/JESD22-A114-A.
2. Tested to EIA/JESD22-A115-A.
3. Tested to JESD22-C101-A.
4. Tested to EIA/JESD78.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{EE}}$ | Negative DC Supply Voltage | (Referenced to GND) | -6.0 | GND | V |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Voltage | (Referenced to GND) (Referenced to $\mathrm{V}_{\mathrm{EE}}$ ) | $\begin{aligned} & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 6.0 \end{aligned}$ | V |
| $\mathrm{V}_{\text {IS }}$ | Analog Input Voltage |  | $\mathrm{V}_{\text {EE }}$ | $\mathrm{V}_{\text {cc }}$ | V |
| $\mathrm{V}_{\text {IN }}$ | Digital Input Voltage | (Note 5) (Referenced to GND) | 0 | 6.0 | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range, All Package Types |  | -55 | 125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{tr}_{\mathrm{r}} \mathrm{tf}$ | Input Rise/Fall Time (Channel Select or Enable Inputs) | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V} \pm 0.3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & 100 \\ & 20 \end{aligned}$ | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
5. Unused inputs may not be left open. All inputs must be tied to a high-logic voltage level or a low-logic input voltage level.

## DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1\% BOND FAILURES

| Junction <br> Temperature ${ }^{\circ} \mathbf{C}$ | Time, Hours | Time, Years |
| :---: | :---: | :---: |
| 80 | $1,032,200$ | 117.8 |
| 90 | 419,300 | 47.9 |
| 100 | 178,700 | 20.4 |
| 110 | 79,600 | 9.4 |
| 120 | 37,000 | 4.2 |
| 130 | 17,800 | 2.0 |
| 140 | 8,900 | 1.0 |



Figure 2. Failure Rate vs. Time Junction Temperature

DC CHARACTERISTICS - Digital Section (Voltages Referenced to GND)

| Symbol | Parameter | Condition | $\underset{\mathrm{V}}{\mathrm{v}_{\mathrm{cc}}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | -55 to $25^{\circ} \mathrm{C}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum High-Level Input Voltage, Channel-Select or Enable Inputs |  | $\begin{aligned} & 2.5 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 1.90 \\ & 2.10 \\ & 3.15 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 1.90 \\ & 2.10 \\ & 3.15 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 1.90 \\ & 2.10 \\ & 3.15 \\ & 4.2 \end{aligned}$ | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Maximum Low-Level Input Voltage, Channel-Select or Enable Inputs |  | $\begin{aligned} & 2.5 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 0.6 \\ 0.9 \\ 1.35 \\ 1.8 \end{gathered}$ | $\begin{gathered} \hline 0.6 \\ 0.9 \\ 1.35 \\ 1.8 \end{gathered}$ | $\begin{gathered} \hline 0.6 \\ 0.9 \\ 1.35 \\ 1.8 \end{gathered}$ | V |
| 1 IN | Maximum Input Leakage Current, Channel-Select or Enable Inputs | $\mathrm{V}_{\mathrm{IN}}=6.0$ or GND | 0 V to 6.0 V | $\pm 0.1$ | $\pm 1.0$ | $\pm 1.0$ | $\mu \mathrm{A}$ |
| Icc | Maximum Quiescent Supply Current (per Package) | Channel Select, Enable and $\mathrm{V}_{\mathrm{IS}}=\mathrm{V}_{\mathrm{CC}}$ or GND | 6.0 | 4.0 | 40 | 80 | $\mu \mathrm{A}$ |

DC ELECTRICAL CHARACTERISTICS - Analog Section

| Symbol | Parameter | Test Conditions | $\mathrm{v}_{\mathrm{cc}}$ | $\mathrm{V}_{\mathrm{EE}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | -55 to $25^{\circ} \mathrm{C}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| RON | Maximum "ON" Resistance | $\begin{aligned} & V_{I N}=V_{I L} \text { or } V_{I H} \\ & V_{I S}=1 / 2\left(V_{\mathrm{CC}}-V_{\text {EE }}\right) \\ & \mid I S=2.0 \mathrm{~mA} \\ & \text { (Figure } 3 \text { ) } \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 3.0 \end{aligned}$ | $\begin{gathered} 0 \\ 0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & \hline 86 \\ & 37 \\ & 26 \end{aligned}$ | $\begin{gathered} \hline 108 \\ 46 \\ 33 \end{gathered}$ | $\begin{aligned} & \hline 120 \\ & 55 \\ & 37 \end{aligned}$ | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} \\ & \mathrm{~V}_{\mathrm{IS}}=1 / 2\left(\mathrm{~V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}\right) \\ & \|\mathrm{IS}\|=2.0 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 3.0 \end{aligned}$ | $\begin{gathered} \hline 0 \\ 0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & \hline 15 \\ & 13 \\ & 10 \end{aligned}$ | $\begin{aligned} & 20 \\ & 18 \\ & 15 \end{aligned}$ | $\begin{aligned} & 20 \\ & 18 \\ & 15 \end{aligned}$ | $\Omega$ |
| 1 off | Maximum Off-Channel Leakage Current, Any One Channel | $\begin{aligned} & \mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{HH}} ; \\ & \mathrm{V}_{\mathrm{IO}}=\mathrm{V}_{\mathrm{CC}} \text { or } G N D ; \\ & \text { Switch Off (Figure 3) } \end{aligned}$ | $\begin{gathered} \hline 5.5 \\ +3.0 \end{gathered}$ | $\begin{gathered} \hline 0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & \hline 0.1 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\mu \mathrm{A}$ |
|  | Maximum Off-Channel Leakage Current, Common Channel | $\begin{aligned} & \mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{HH}} ; \\ & \mathrm{V}_{1 \mathrm{O}}=\mathrm{V}_{\mathrm{CC}} \text { or } G N D ; \\ & \text { Switch Off (Figure 4) } \end{aligned}$ | $\begin{gathered} 5.5 \\ +3.0 \end{gathered}$ | $\begin{gathered} 0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & 0.2 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 4.0 \end{aligned}$ |  |
| $\mathrm{I}_{\text {on }}$ | Maximum On-Channel Leakage Current, Channel-to-Channel | $\mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\mathrm{IH}} ;$ <br> Switch-to-Switch = $\mathrm{V}_{\mathrm{CC}}$ or GND; (Figure 5) | $\begin{gathered} 5.5 \\ +3.0 \end{gathered}$ | $\begin{gathered} 0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & \hline 0.2 \\ & 0.2 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 4.0 \end{aligned}$ | $\mu \mathrm{A}$ |

AC CHARACTERISTICS (Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns}$ )

| Symbol | Parameter | Test Conditions | $\mathrm{v}_{\mathrm{cc}}$ | $\underset{\mathrm{VE}}{\mathrm{~V}_{\mathrm{EE}}}$ | Guaranteed Limit |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | -55 to $25^{\circ} \mathrm{C}$ |  | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
|  |  |  |  |  | Min | Typ* |  |  |  |
| $\mathrm{t}_{\text {BBM }}$ | Minimum Break-Before-Make Time | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {IL }}$ or $\mathrm{V}_{\text {IH }}$ | 3.0 | 0.0 | 1.0 | 6.5 | - | - | ns |
|  |  | $V_{\text {IS }}=V_{\text {V }} \mathrm{CC}$ | 4.5 | 0.0 | 1.0 | 5.0 | - | - |  |
|  |  | $R_{L}=300 \Omega, C_{L}=35 \mathrm{pF}$ <br> (Figures 11 and 12) | 3.0 | -3.0 | 1.0 | 3.5 | - | - |  |

${ }^{*}$ Typical Characteristics are at $25^{\circ} \mathrm{C}$.
AC CHARACTERISTICS ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns}$ )

| Symbol | Parameter | $\underset{\mathrm{V}}{\mathrm{v}_{\mathrm{cc}}}$ | $\mathrm{v}_{\mathrm{EE}}^{\mathrm{V}}$ | Guaranteed Limit |  |  |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | -55 to $25^{\circ} \mathrm{C}$ |  |  | $\leq 85^{\circ} \mathrm{C}$ |  | $\leq 125^{\circ} \mathrm{C}$ |  |  |
|  |  |  |  | Min | Typ | Max | Min | Max | Min | Max |  |
| $\begin{aligned} & \text { tpLH, } \\ & t_{\text {tPHL }} \end{aligned}$ | Maximum Propagation Delay, Channel-Select to Analog Output (Figures 15 and 16) | $\begin{aligned} & 2.5 \\ & 3.0 \\ & 4.5 \\ & 3.0 \end{aligned}$ | $\begin{gathered} 0 \\ 0 \\ 0 \\ -3.0 \end{gathered}$ |  |  | $\begin{aligned} & 40 \\ & 28 \\ & 23 \\ & 23 \end{aligned}$ |  | $\begin{aligned} & 45 \\ & 30 \\ & 25 \\ & 25 \end{aligned}$ |  | $\begin{aligned} & 50 \\ & 35 \\ & 30 \\ & 28 \end{aligned}$ | ns |
| $\begin{aligned} & \text { tpLZ, } \\ & \text { tPHZ } \end{aligned}$ | Maximum Propagation Delay, Enable to Analog Output (Figures 13 and 14) | $\begin{aligned} & \hline 2.5 \\ & 3.0 \\ & 4.5 \\ & 3.0 \end{aligned}$ | $\begin{gathered} \hline 0 \\ 0 \\ 0 \\ -3.0 \end{gathered}$ |  |  | $\begin{aligned} & 40 \\ & 28 \\ & 23 \\ & 23 \end{aligned}$ |  | 45 30 25 25 |  | $\begin{aligned} & 50 \\ & 35 \\ & 30 \\ & 28 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \mathrm{tpzL}^{\prime} \\ & \mathrm{t}_{\mathrm{PzH}} \end{aligned}$ | Maximum Propagation Delay, Enable to Analog Output (Figures 13 and 14) | $\begin{aligned} & \hline 2.5 \\ & 3.0 \\ & 4.5 \\ & 3.0 \end{aligned}$ | $\begin{gathered} 0 \\ 0 \\ 0 \\ -3.0 \end{gathered}$ |  |  | $\begin{aligned} & 40 \\ & 28 \\ & 23 \\ & 23 \end{aligned}$ |  | 45 30 25 25 |  | 50 35 30 28 | ns |


| $\mathrm{C}_{\text {PD }}$ | Power Dissipation Capacitance (Figure 17) (Note 6) |  | Typical @ $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ | pF |
| :---: | :---: | :---: | :---: | :---: |
|  |  |  | 45 |  |
| $\mathrm{C}_{\text {IN }}$ | Maximum Input Capacitance, Channel-Select or Enable Inputs |  | 10 | pF |
| $\mathrm{Cl}_{1 / \mathrm{O}}$ | Maximum Capacitance (All Switches Off) | Analog I/O Common O/l Feedthrough | $\begin{aligned} & 10 \\ & 10 \\ & 1.0 \end{aligned}$ | pF |

6. Used to determine the no-load dynamic power consumption: $P_{D}=C_{P D} V_{C C}{ }^{2} f+I_{C C} V_{C C}$.

ADDITIONAL APPLICATION CHARACTERISTICS (GND = 0 V )

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}$ V | $\mathrm{v}_{\mathrm{EE}}$ | Typ | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | $25^{\circ} \mathrm{C}$ |  |
| BW | Maximum On-Channel Bandwidth or Minimum Frequency Response | $\begin{array}{\|l} \hline V_{\text {IS }}=1 / 2\left(V_{C C}-V_{\text {EE }}\right) \\ \text { Ref and Test Attn }=10 \mathrm{~dB} \\ \text { Source Amplitude }=0 \mathrm{~dB} \\ \text { (Figure 6) } \end{array}$ | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 6.0 \\ & 3.0 \end{aligned}$ | $\begin{gathered} 0.0 \\ 0.0 \\ 0.0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & 80 \\ & 80 \\ & 80 \\ & 80 \end{aligned}$ | MHz |
| $\mathrm{V}_{\text {ISO }}$ | Off-Channel Feedthrough Isolation | $f=1 \mathrm{MHz} ; \mathrm{V}_{\mathrm{IS}}=1 / 2\left(\mathrm{~V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}\right)$ <br> Adjust Network Analyzer output to 10 dBm on each output from the power splitter (Figures 7 and 8) | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 6.0 \\ & 3.0 \end{aligned}$ | $\begin{gathered} \hline 0.0 \\ 0.0 \\ 0.0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & -70 \\ & -70 \\ & -70 \\ & -70 \end{aligned}$ | dB |
| $\mathrm{V}_{\text {ONL }}$ | Maximum Feedthrough On Loss | $V_{I S}=1 / 2\left(V_{C C}-V_{E E}\right)$ <br> Adjust Network Analyzer output to 10 dBm on each output from the power splitter <br> (Figure 10) | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 6.0 \\ & 3.0 \end{aligned}$ | $\begin{gathered} \hline 0.0 \\ 0.0 \\ 0.0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & -2 \\ & -2 \\ & -2 \\ & -2 \end{aligned}$ | dB |
| Q | Charge Injection | $\begin{aligned} & V_{I N}=V_{C C} \text { to } V_{E E,} f_{I S}=1 \mathrm{kHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3 \mathrm{~ns} \\ & \mathrm{R}_{I S}=0 \Omega, C_{L}=1000 \mathrm{pF}, \mathrm{Q}=C_{L}{ }^{*} \Delta V_{\text {OUT }} \\ & \text { (Figure 9) } \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 3.0 \end{aligned}$ | $\begin{gathered} \hline 0.0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & \hline 9.0 \\ & 12 \end{aligned}$ | pC |
| THD | Total Harmonic Distortion THD + Noise | $f_{I S}=1 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{~K} \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF},$ <br> $\mathrm{V}_{\text {IS }}=5.0 \mathrm{~V}_{\mathrm{PP}}$ sine wave <br> $\mathrm{V}_{\text {IS }}=6.0 \mathrm{~V}_{\mathrm{PP}}$ sine wave <br> (Figure 18) | $\begin{aligned} & 6.0 \\ & 3.0 \end{aligned}$ | $\begin{gathered} 0.0 \\ -3.0 \end{gathered}$ | $\begin{aligned} & 0.10 \\ & 0.05 \end{aligned}$ | \% |



Figure 3. On Resistance, Test Set-Up


Figure 4. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up


Figure 5. Maximum On Channel Leakage Current, Channel to Channel, Test Set-Up


Figure 6. Maximum On Channel Bandwidth, Test Set-Up


Figure 7. Maximum Off Channel Feedthrough Isolation, Test Set-Up


Figure 8. Maximum Common-Channel Feedthrough Isolation, Test Set-Up

*Includes all probe and jig capacitance.


Figure 9. Charge Injection, Test Set-Up


Figure 10. Maximum On Channel Feedthrough On Loss, Test Set-Up


Figure 11. Break-Before-Make, Test Set-Up


Figure 13. Propagation Delays, Channel Select to Analog Out


Figure 15. Propagation Delays, Enable to Analog Out

Figure 16. Propagation Delay, Test Set-Up Enable to Analog Out

## MC74LVX4052



Figure 17. Power Dissipation Capacitance, Test Set-Up


Figure 18. Total Harmonic Distortion, Test Set-Up

## MC74LVX4052

## APPLICATIONS INFORMATION

The Channel Select and Enable control pins should be at $\mathrm{V}_{\mathrm{CC}}$ or GND logic levels. $\mathrm{V}_{\mathrm{CC}}$ being recognized as a logic high and GND being recognized as a logic low. In this example:

$$
\begin{gathered}
\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}=\text { logic high } \\
\mathrm{GND}=0 \mathrm{~V}=\text { logic low }
\end{gathered}
$$

The maximum analog voltage swing is determined by the supply voltages $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$. The positive peak analog voltage should not exceed $\mathrm{V}_{\mathrm{CC}}$. Similarly, the negative peak analog voltage should not go below $\mathrm{V}_{\mathrm{EE}}$. In this example, the difference between $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ is 5.0 volts. Therefore, using the configuration of Figure 20, a maximum analog signal of 5.0 volts peak-to-peak can be controlled. Unused analog inputs/outputs may be left floating (i.e., not connected). However, tying unused analog inputs and


Figure 19. Application Example
outputs to $\mathrm{V}_{\mathrm{CC}}$ or GND through a low value resistor helps minimize crosstalk and feedthrough noise that may be picked up by an unused switch.

Although used here, balanced supplies are not a requirement. The only constraints on the power supplies are that:

$$
\begin{gathered}
\mathrm{V}_{\mathrm{EE}}-\mathrm{GND}=0 \text { to }-6 \text { volts } \\
\mathrm{V}_{\mathrm{CC}}-\mathrm{GND}=2.5 \text { to } 6 \text { volts } \\
\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}=2.5 \text { to } 6 \text { volts } \\
\text { and } \mathrm{V}_{\mathrm{EE}} \leq \mathrm{GND}
\end{gathered}
$$

When voltage transients above $\mathrm{V}_{\mathrm{CC}}$ and/or below $\mathrm{V}_{\mathrm{EE}}$ are anticipated on the analog channels, external Germanium or Schottky diodes $\left(\mathrm{D}_{\mathrm{x}}\right)$ are recommended as shown in Figure 21. These diodes should be able to absorb the maximum anticipated current surges during clipping.


Figure 20. Application Example


Figure 21. External Germanium or Schottky Clipping Diodes


Figure 22. Function Diagram, LVX4052

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| MC74LVX4052DG | SOIC-16 <br> (Pb-Free) | 48 Units / Rail |
| MC74LVX4052DR2G | SOIC-16 <br> (Pb-Free) | 2500 Tape \& Reel |
| MC74LVX4052DTG | TSSOP-16 <br> (Pb-Free) | 96 Units / Rail |
| MC74LVX4052DTR2G | TSSOP-16 <br> (Pb-Free) | 2500 Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MC74LVX4052

## PACKAGE DIMENSIONS

TSSOP-16
CASE 948F
ISSUE B

*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## PACKAGE DIMENSIONS

SOIC-16
CASE 751B-05
ISSUE K


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLING DIMENSION: MLLIMETER.
2. DIMENSIONS A AND B DO NOT INCLUDE MOLD

PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR

PROTRUSION. ALLOWABLE DAMBAR PROTRUSION
SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | ---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 9.80 | 10.00 | 0.386 | 0.393 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.054 | 0.068 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.40 | 1.25 | 0.016 | 0.049 |
| G | 1.27 BSC |  | 0.050 |  |
| BSC |  |  |  |  |
| J | 0.19 | 0.25 | 0.008 | 0.009 |
| K | 0.10 | 0.25 | 0.004 | 0.009 |
| M | $0^{\circ}$ | $7^{\circ}$ | $0^{\circ}$ | $7^{\circ}$ |
| P | 5.80 | 6.20 | 0.229 | 0.244 |
| R | 0.25 | 0.50 | 0.010 | 0.019 |

SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS
*For additional information on our Pb -Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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